Attorney's Docket No.: 110348-135118 Page 1 of 3
First Named Inventor: Vijayakumar S. RamachandraRao Application No.: Not Yet Assigned
Title: Wafer Stacking Using Copper Structures Of Substantially Uniform Height
Express Mail Label No. ER084884161US Date of Deposit: 3/31/2004

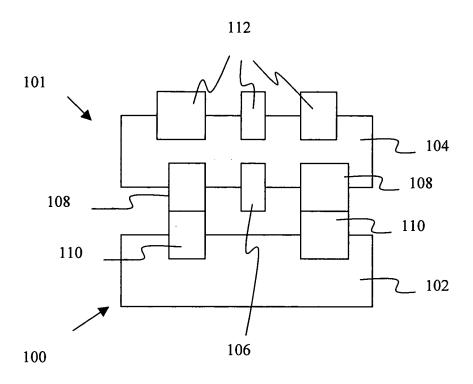
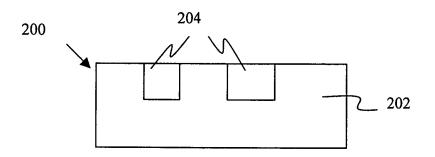


Figure 1



. - - (1) ·

Figure 2A

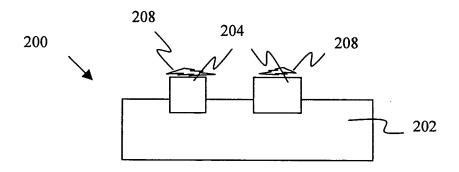


Figure 2B

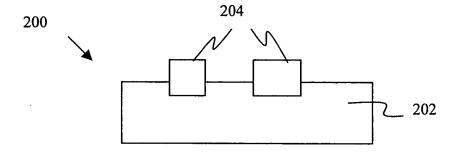


Figure 2C

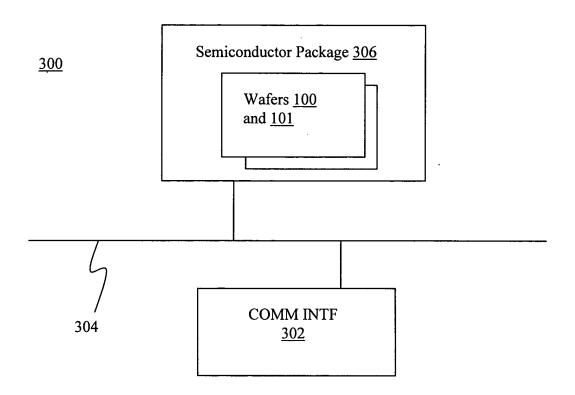


FIGURE 3